

I hereby certify that this correspondence is being filed via
EFS-Web with the United States Patent and Trademark Office
on March 19, 2007.

TOWNSEND and TOWNSEND and CREW LLP

By: /Bonnie Rickles/
Bonnie Rickles

PATENT
Atty Docket No.: A7729/T78410
AMAT No.: 007729 USA/TCG/EPI/AG
TTC No.: 016301-078410US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Kaushal Singh et al.

Application No.: 10/688,797

Filed: October 17, 2003

For: SILICON-CONTAINING LAYER
DEPOSITION WITH SILICON
COMPOUNDS

Customer No.: 57385

Confirmation No. 9712

Examiner: KUNEMUND, ROBERT M.

Technology Center/Art Unit: 1722

AMENDMENT ACCOMPANYING RCE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Please enter the following claim Amendment in the above-identified application:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 14 of this paper.